

Printed Electronics Helix Launch Event

21 September

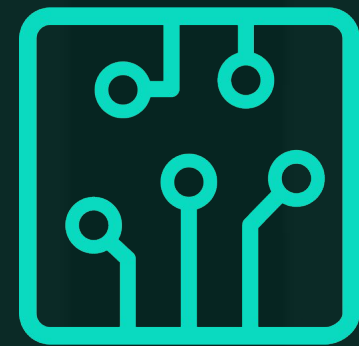
The REFORM Project for the environmental and sustainability
challenges around functional electronics,

Yolanda Alesanco, CIDETEC



01

Functional Electronics - Opportunities & Risks

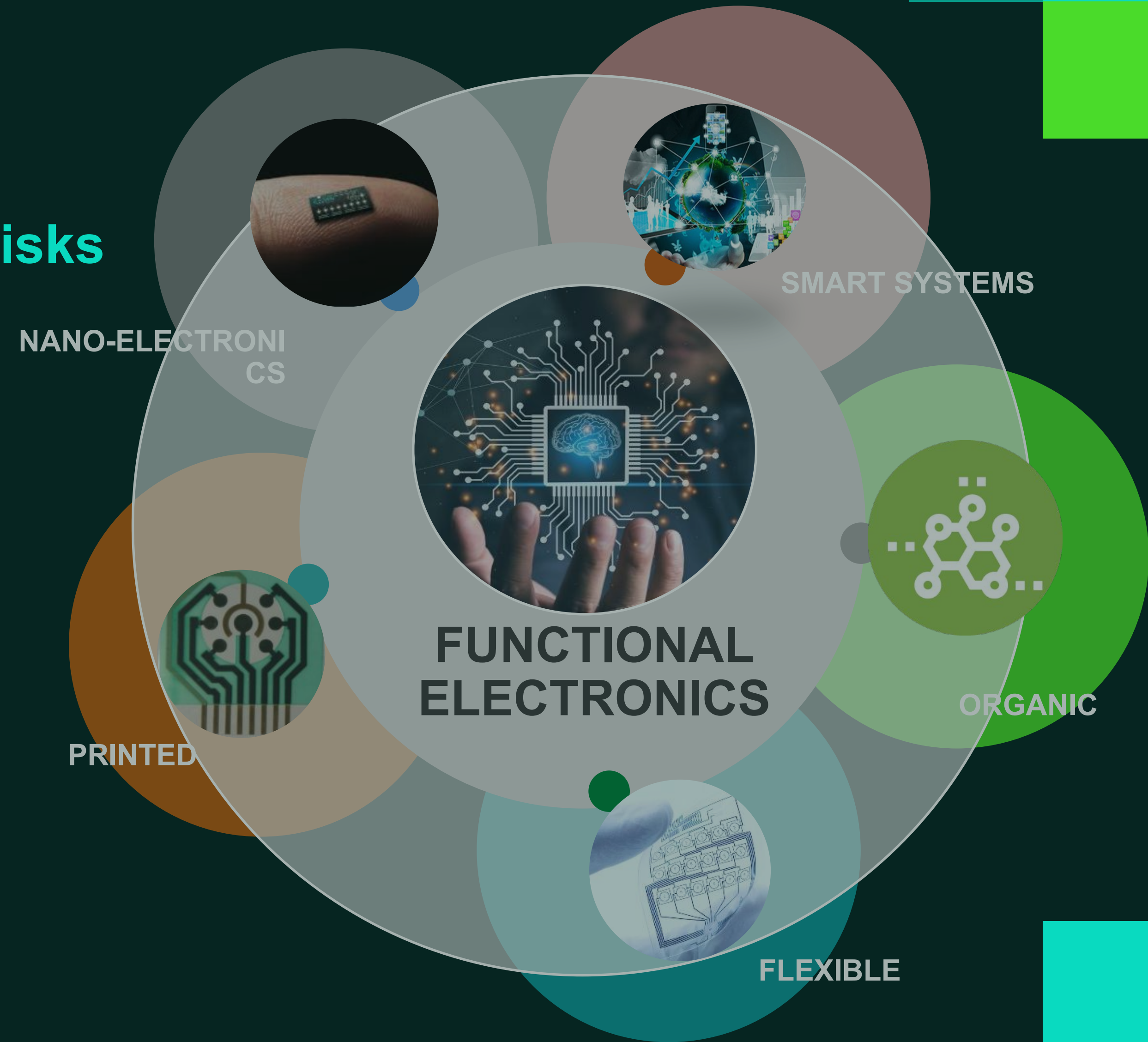


Opportunities

- Transversal enabler of European digital transformation
- Support a multitude of key enabling technology advances
- Total market will grow to \$74 billion in 2030
- (IDTechEx Research)

Risks

- Environmental and resource impact



02

Functional Electronics - Environmental impact

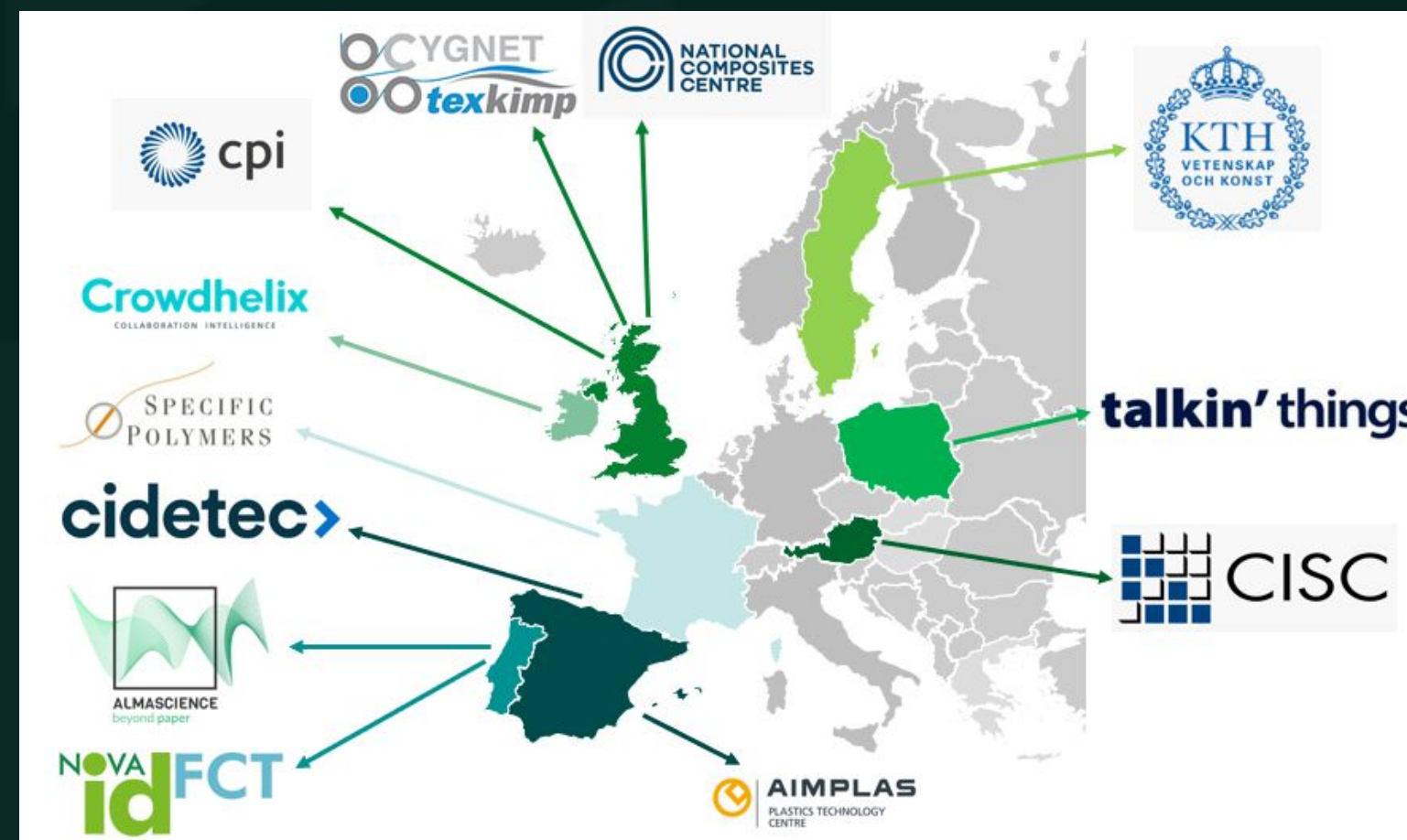
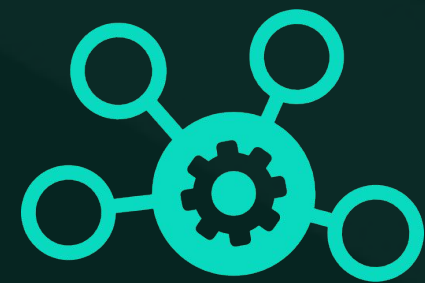
- Increasing demand on electronics and ever shorter product lifecycles □ generation of more e-waste
- Waste electrical and electronic equipment (WEEE) is considered one of the fastest-growing waste streams in the EU and globally
- In 2019, approximately 53.6 Mt of e-waste were generated, and it is increasing at an alarming rate of 2 Mt per year
- Only around 20–25% of e-waste is assumed to be formally recycled
- Europe: 15 kg e-waste generated for every person in 2019

If Europe is going to take the global lead in functional electronics □ ensure that do not become the electronic-waste problem of the future

03

REFORM Project - Concept & Consortium

- Address the environmental and sustainability challenges around conventional functional electronics
- Use ecodesign principles to ensure:
 - ✓ meet the requirements of multiple high-performance applications
 - ✓ meet societal and environmental needs for sustainability



FUNDING	4,993,610.00 €	
European Union Horizon Europe (HORIZON):	3,588,155.75 €	
UK partners:	1,405,454.25 €	

Start: **1st** January 2023

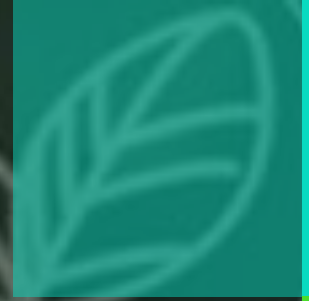
End: **30st** June 2026

42 months

8 Countries

12 Partners

6 RTO
5 SME
1 UNI



04

REFORM Project – main objectives

- Develop environmentally benign electronic 'building blocks' focusing on green, bio-derived

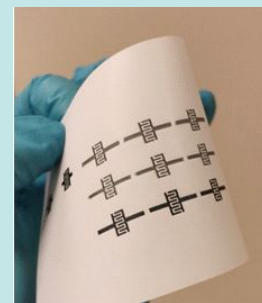


Conductive inks
Flexible substrates
Adhesives

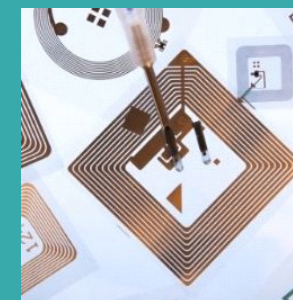


Fully organic conductive inks
Cellulose-based electrolytes
Cellulose-based substrates
Recyclable thermoset 3R composite
Debondable adhesives

- Integrate into industry-led functional electronics systems, supported by innovations in conformance testing and material recovery methods.



Metal-free on-paper microsupercapacitors



RFID tags for smart logistics



Embedded pressure vessel sensors



Thanks

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